

JUL 17 2003

PATENT & TRADEMARK OFFICE

PATENT APPLICATION

IN THE U.S. PATENT AND TRADEMARK OFFICE

July 14, 2003

Applicant(s): Chikao IKENAGA et al.

For: FRAME FOR SEMICONDUCTOR PACKAGE INCLUDING PLURAL LEAD
FRAMES HAVING THIN PARTS OR HOLLOW ADJACENT THE
TERMINAL ROOTS

Serial No.: 09/850 213

Group: 2826

Confirmation No.: 9610

Filed: May 7, 2001

Examiner: P. Greene

International Application No.: N/A

International Filing Date: N/A

Atty. Docket No.: OPS Case 533

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

RESPONSE

Sir:

In response to the Office Action dated March 13, 2003,
please amend the above-identified application as follows:

(Please see following pages.)

CERTIFICATE OF MAILING

I hereby certify that this correspondence is being
deposited with the United States Postal Service with
sufficient postage as first class mail in an envelope
addressed to: Commissioner for Patents, P.O. Box 1450,
Alexandria, VA 22313-1450, on July 14, 2003.

Liane L. Churney
Liane L. Churney

07/16/2003 SDENBOB1 00000066 09850213

01 FC:1251

110.00 OP

*Please enter
amendment
9/5/03*

TECHNOLOGY CENTER 2800

JUL 23 2003

RECEIVED